

SST12LP20 is a RF-matched power amplifier module based on the highly-reliable InGaP/GaAs HBT technology. This amplifier includes DC blocks and provides both input and output match to 50Ω . Operating over the 2.4–2.5 GHz frequency band, the amplifier typically provides 30 dB gain with 28% power-added efficiency at 21 dBm. SST12LP20 has excellent linearity with typically 18 dBm at 3% EVM for 54 Mbps 802.11g modulation, while meeting 802.11g spectrum mask at 21 dBm. It requires only two external bias components, and features easy board-level usage, along with high-speed power-up/down control through a single combined reference voltage pin. SST12LP20 is offered in an 8-contact USON package.

Features

· High gain:

- Typically 30 dB gain across 2.4-2.5 GHz over temperature 0°C to +85°C and 29 dB gain from -40°C to 0°C

High linear output power:

- ->24 dBm P1dB
- Single-tone measurement. Please refer to "Absolute
- Single-tone measurement. Please relef to Absolute Maximum Stress Ratings" on page 5
 Meets 802.11g OFDM ACPR requirement up to 21 dBm
 ~3% added EVM up to 18 dBm for 54 Mbps 802.11g signal 802.11n HT20 ACPR requirement up to 18 dBm
 Meets 802.11b ACPR requirement up to 21 dBm

- High power-added efficiency/Low operating current for 802.11b/g/n applications

-~28%/138 mA @ POUT = 21 dBm for 802.11b/g

Single-pin low I_{REF} power-up/down control

– I_{REF} <2 mA

Low idle current

-~78 mA Ico

- High-speed power-up/down
 - Turn on/off time (10%- 90%) <100 ns
 - Typical power-up/down delay with driver delay included <200 ns
- Low shut-down current (~2 µA)

- Small variation over temperature – ~1 dB gain/power variation between 0°C to +85°C
- Excellent on-chip power detection ->15 dB dynamic range, dB-wise Linear Temperature stable and load insensitive
- Input port matched to 50 Ω internally
- Both input and output ports are DC decoupled.
- Packages available - 8-contact USON - 2mm x 2mm x 0.55mm
- All non-Pb (lead-free) devices are RoHS compliant

Applications

- WLAN (IEEE 802.11b/g/n)
- Home RF
- Cordless phones
- 2.4 GHz ISM wireless equipment



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Product Description

SST12LP20 is a versatile power amplifier based on the highly-reliable InGaP/GaAs HBT technology. The device's input and output ports are matched to 50Ω internally. Both input and output ports are DC-decoupled and do not require DC-blocking capacitors. This helps reduce the system board's Bill of Materials (BOM) cost.

The SST12LP20 is a 2.4 GHz high-efficiency Power Amplifier designed in compliance with IEEE 802.11b/g/n applications. It typically provides 30 dB gain with 28% power-added efficiency (PAE) @ POUT = 21 dBm for 802.11b/g.

The SST12LP20 has excellent linearity, typically ~3% added EVM at 18 dBm output power which is essential for 54 Mbps 802.11g operation while meeting 802.11g spectrum mask at 21 dBm and 802.11b spectrum mask at 21 dBm.

The SST12LP20 also features easy board-level usage along with high-speed power-up/down control through a single combined reference voltage pin. Ultra-low reference current (total $I_{REF} \sim 2$ mA) makes the SST12LP20 controllable by an on/off switching signal directly from the baseband chip. These features, coupled with low operating current, make the SST12LP20 ideal for the final stage power amplification in battery-powered 802.11b/g/n WLAN transmitter applications.

The SST12LP20 has an excellent on-chip, single-ended power detector, which features wide-range (>15 dB) with dB-wise linear. The excellent on-chip power detector provides a reliable solution to board-level power control.

The SST12LP20 is offered in 8-contact USON package. See Figure 2 for pin assignments and Table 1 for pin descriptions.



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Functional Blocks





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Pin Assignments



Figure 2: Pin Assignments for 8-contact USON

Pin Descriptions

Symbol	Pin No.	Pin Name	Type ¹	Function	
GND	0	Ground		Low inductance ground pad	
RFIN	1		I	RF input, DC decoupled	
DNU	2	Do Not Use		Do not use or connect	
DNU	3	Do Not Use		Do not use or connect	
RFOUT	4		0	RF output, DC decoupled	
VCC2	5	Power Supply	PWR	Power Supply, 2 nd stage	
VCC1	6	Power Supply	PWR	Power Supply, 1 st stage	
DET	7		0	On-chip power detector	
VREF	8		PWR	1 st and 2 nd stage idle current control	
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Table 1: Pin Description

1. I=Input, O=Output



Electrical Specifications

The RF and DC specifications for the power amplifier interface signals. Refer to Table 3 for the DC voltage and current specifications, Table 4 for RF specifications, and Figures 3 through 8 for the RF performance.

Absolute Maximum Stress Ratings (Applied conditions greater than those listed under "Absolute Maximum Stress Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these conditions or conditions greater than those defined in the operational sections of this data sheet is not implied. Exposure beyond absolute maximum stress rating conditions may affect device reliability.)

Input power to pin 1 (P _{IN})	
Average output power from pin 4 (P _{OUT}) ¹ +25.5 dBm	
Supply Voltage at pins 5 and 6(V _{CC})	
Reference voltage to pin 8 (V _{REF})0.3V to +4.0V	
DC supply current (I _{CC}) ² 350 mA	
Operating Temperature (T _A)40°C to +85°C	
Storage Temperature (T _{STG})	
Maximum Junction Temperature (T _J)+150°C	
Surface Mount Solder Reflow Temperature	
1. Never measure with CW source. Pulsed single-tone source with <50% duty cycle is recommended. Exceeding the max- imum rating of average output power could cause permanent damage to the device.	
2. Measured with 100% duty cycle 54 Mbps 802.11g OFDM Signal	

Measured with 100% duty cycle 54 Mbps 802.11g OFDM Signal

Table 2: Operating Range

Range	Ambient Temp	V _{DD}
Industrial	-40°C to +85°C	3.3V

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Table 3: DC Electrical Characteristics at 25°C

Symbol	Parameter	Min.	Тур	Max.	Unit
V _{CC}	Supply Voltage at pins 5 and 6	3.0	3.3	4.2	V
I _{CQ}	Idle current to meet EVM ~3% @ 18 dBm Output Power, 802.11g OFDM 54 Mbps signal		75		mA
V _{REG}	Reference Voltage for pin 8	3.05	3.10	3.15	V
Icc	Current consumption to meet 802.11g OFDM 54 Mbps spectrum mask @ 21 dBm		140		mA
	Current consumption to meet 802.11b DSSS 54 Mbps spectrum mask @ 21 dBm		140		mA
	Current consumption to meet EVM ~3% @ 18 dBm Output Power with 802.11g OFDM 54 Mbps signal		110		mA

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Table 4:	RF Characteristics	at 25°C
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Symbol	Parameter	Min.	Тур	Max.	Unit
F _{L-U}	Frequency range	2412		2484	MHz
G	Small signal gain	28	30		dB
G _{VAR1}	Gain variation over band (2412–2484 MHz)			±0.5	dB
G _{VAR2}	Gain ripple over channel (20 MHz)		0.2		dB
2f, 3f, 4f, 5f	Harmonics at 22 dBm, without external filters		-25		dBc
EVM	Added EVM @ 18 dBm output with 802.11g OFDM 54 Mbps signal		3		%
Pout	Output Power to meet 802.11g OFDM 54 Mbps spectrum mask	20	21		dBm
	Output Power to meet 802.11b DSSS 1 Mbps spectrum mask	20	21		dBm
	Output Power to meet 802.11n HT20 65 Mbps spectrum mask	18	20		dBm

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Typical Performance Characteristics

Test Conditions: V_{CC} = 3.3V, T_A = 25°C, unless otherwise specified



Figure 3: S-Parameters



Typical Performance Characteristics

Test Conditions: V_{CC} = 3.3V, T_A = 25°C, 54 Mbps 802.11g OFDM Signal



Figure 4: EVM versus Output Power measured with Equalizer Channel Estimation set to "Sequence Only"



Figure 5: Power Gain versus Output Power



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Figure 7: PAE versus Output Power



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Figure 8: Detector Characteristics versus Output Power



Figure 9: Typical Schematic for High-Efficiency 802.11b/g Applications



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Product Ordering Information



1. Environmental suffix "E" denotes non-Pb solder. SST non-Pb solder devices are "RoHS Compliant".

Valid combinations for SST12LP20

SST12LP20-QUAE

SST12LP20 Evaluation Kits

SST12LP20-QUAE-K

Note: Valid combinations are those products in mass production or will be in mass production. Consult your SST sales representative to confirm availability of valid combinations and to determine availability of new combinations.



Packaging Diagrams



Figure 10:8-Contact Ultra-thin Small Outline No-lead (USON) SST Package Code: QUA



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Table 5: Revision History

Revision	Description	Date
00	Initial release of data sheet	May 2010
A	• Revised "Features" on page 1 and "Product Description" on page 2	Jan 2012
	 Updated Figure 1 and Figures 3-9 	
	Modified Tables 3 and 4	
	Applied new document format	
	Released document under letter revision system	
	 Updated Spec number from S71427 to DS75049 	
В	Revised maximum Reference voltage from 3.3V to 4.0V in "Absolute Maximum Stress Ratings" on page 5	Apr 2012
	Updated Figure 10 on page 12	
С	 Changed the document status from "Preliminary Specification" to "Data Sheet" 	May 2013

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